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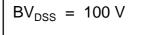
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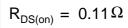
Advanced Power MOSFET

IRF530A

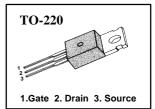
FEATURES

- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- 175°C Operating Temperature
- Lower Leakage Current : 10 μ A (Max.) @ V_{DS} = 100V
- Lower $R_{DS(ON)}$: 0.092 $\Omega(Typ.)$









Absolute Maximum Ratings

Symbol	Characteristic	Value	Units		
V _{DSS}	Drain-to-Source Voltage		100	V	
	Continuous Drain Current (T _c =25 ° _C)		14		
I _D Continuous Drain Current (T _c =100 °C)		9.9			
I _{DM}	Drain Current-Pulsed	D	56	А	
V _{GS}	Gate-to-Source Voltage		± 20	V	
E _{AS}	Single Pulsed Avalanche Energy	2	261	mJ	
I _{AR}	Avalanche Current	D	14	А	
E _{AR}	Repetitive Avalanche Energy	0	5.5	mJ	
dv/dt	Peak Diode Recovery dv/dt	•	6.5	V/ns	
	Total Power Dissipation (T _c =25° _C)		55	W	
P _D	Linear Derating Factor		0.36	W/°C	
	Operating Junction and				
T _J , T _{STG}	Storage Temperature Range		- 55 to +175	°C	
	Maximum Lead Temp. for Soldering		200		
TL	Purposes, 1/8" from case for 5-seconds		300		

Thermal Resistance

Symbol	Characteristic	Тур.	Max.	Units
R _{θJC}	Junction-to-Case		2.74	
R _{0CS}	Case-to-Sink	0.5		°C/W
R _{θJA}	Junction-to-Ambient		62.5	



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N-CHANNEL POWER MOSFET

Symbol	Characteristic	Min.	Тур.	Max.	Units	Test Condition	
BV _{DSS}	Drain-Source Breakdown Voltage	100	-		V	V _{GS} =0V,I _D =250	
$\Delta BV/\Delta T_{J}$	Breakdown Voltage Temp. Coeff.		0.11		V/ °C	I _D =250 μA See Fig 7	
V _{GS(th)}	Gate Threshold Voltage	2.0	-	4.0	V	V _{DS} =5V,I _D =250µA	
	Gate-Source Leakage, Forward			100	nA	V _{GS} =20V	
I _{GSS}	Gate-Source Leakage, Reverse			-100		V _{GS} =-20V	
	Drain to Courses Lookana Current			10		V _{DS} =100V	
I _{DSS}	Drain-to-Source Leakage Current			100	μA	V _{DS} =80V,T _C =150°C	
Б	Static Drain-Source				0	$V_{aa}=10V_{aa}=7A$	
R _{DS(on)}	On-State Resistance		0.11 Ω		52	$V_{\rm GS} = 10V, I_{\rm D} = 7A \qquad (4)$	
9 _{fs}	Forward Transconductance		10.25		Ω	V _{DS} =40V,I _D =7A ④	
C _{iss}	Input Capacitance		610	790	(1 - 0)/(1 - 25)/(f - 1)/(1 - 25)/(f - 1)/(f - 25)/(f - 25)/		
C _{oss}	Output Capacitance		150	175	pF	V _{GS} =0V,V _{DS} =25V,f =1MHz See Fig 5	
C _{rss}	Reverse Transfer Capacitance		62	72		See rig 5	
t _{d(on)}	Turn-On Delay Time		13	40		V _{DD} =50V,I _D =14A,	
t _r	Rise Time		14	40		$R_{G}=12\Omega$	
t _{d(off)}	Turn-Off Delay Time		55	110	ns		
t _f	Fall Time		36	80		See Fig 13 ④⑤	
Q _g	Total Gate Charge		27	36		V _{DS} =80V,V _{GS} =10V,	
Q _{gs}	Gate-Source Charge		4.5		nC	I _D =14A	
Q _{gd}	Gate-Drain("Miller") Charge		12.8			See Fig 6 & Fig 12 $@$	

Electrical Characteristics (T_C =25°C unless otherwise specified)

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Тур.	Max.	Units	Test Condition
ا _s	Continuous Source Current			14	^	Integral reverse pn-diode
I _{SM}	Pulsed-Source Current ()			56	А	in the MOSFET
V _{SD}	Diode Forward Voltage			1.5	V	T _J =25°C,I _S =14A,V _{GS} =0V
t _{rr}	Reverse Recovery Time		109		ns	T _J =25°C,I _F =14A
Q _{rr}	Reverse Recovery Charge		0.41		¥ìC	di _F /dt=100A/µs ④

Notes;

- () Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- 2 L=2mH, I_{AS} =14A, V_{DD} =25V, R_{G} =27 Ω , Starting T_{J} =25 °C

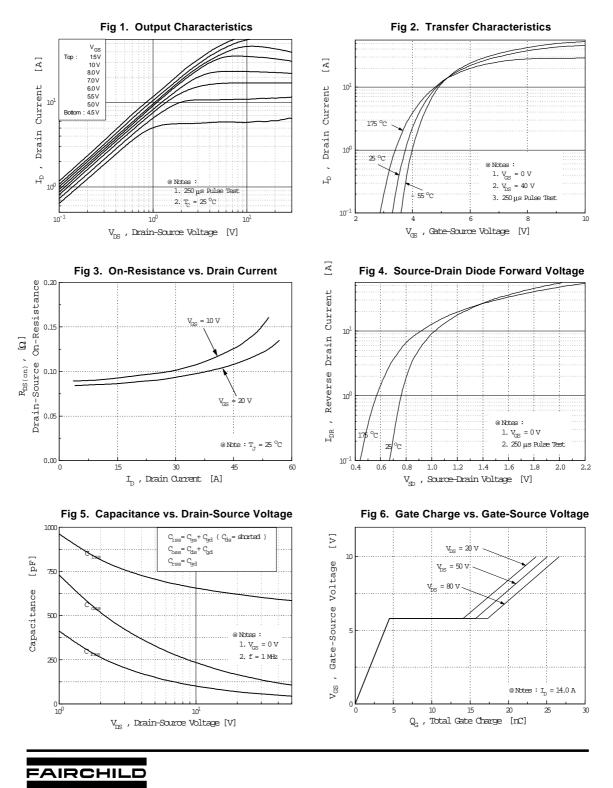
- **(5)** Essentially Independent of Operating Temperature

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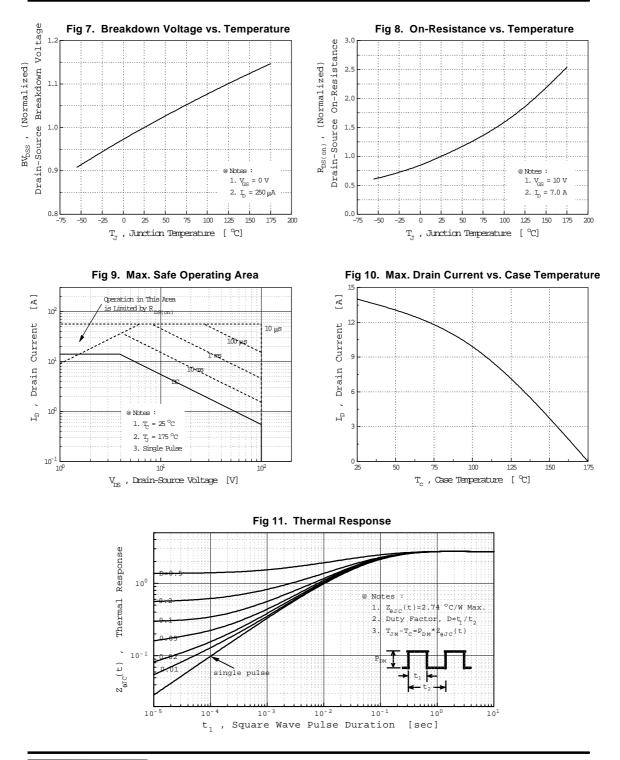
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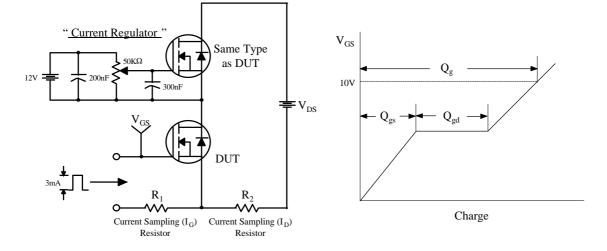


Fig 12. Gate Charge Test Circuit & Waveform



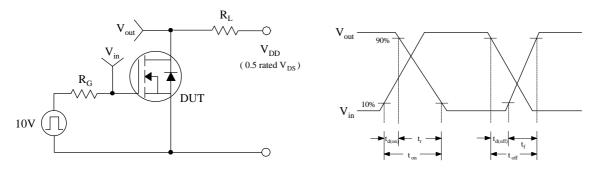
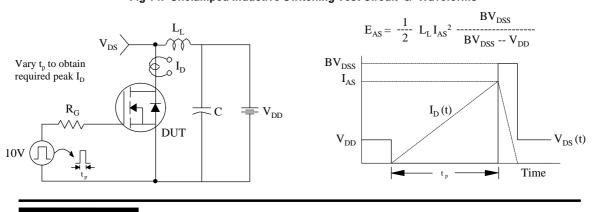
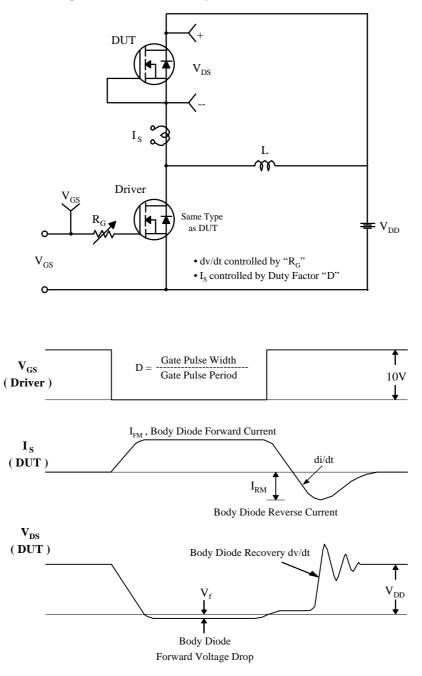
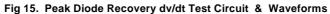


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms









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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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